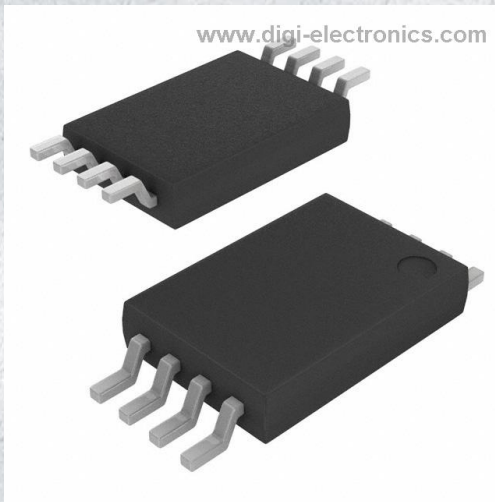


# FDW254PZ Datasheet



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DiGi Electronics Part Number	FDW254PZ-DG
Manufacturer	<a href="#">onsemi</a>
Manufacturer Product Number	FDW254PZ
Description	MOSFET P-CH 20V 9.2A 8TSSOP
Detailed Description	P-Channel 20 V 9.2A (Ta) 1.4W (Ta) Surface Mount 8-TSSOP



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## Purchase and inquiry

Manufacturer Product Number:

FDW254PZ

Series:

PowerTrench®

FET Type:

P-Channel

Drain to Source Voltage (Vdss):

20 V

Drive Voltage (Max Rds On, Min Rds On):

1.8V, 4.5V

Vgs(th) (Max) @ Id:

1.5V @ 250µA

Vgs (Max):

±8V

FET Feature:

-

Operating Temperature:

-55°C ~ 150°C (Tj)

Supplier Device Package:

8-TSSOP

Base Product Number:

FDW25

Manufacturer:

onsemi

Product Status:

Obsolete

Technology:

MOSFET (Metal Oxide)

Current - Continuous Drain (Id) @ 25°C:

9.2A (Ta)

Rds On (Max) @ Id, Vgs:

12mOhm @ 9.2A, 4.5V

Gate Charge (Qg) (Max) @ Vgs:

96 nC @ 4.5 V

Input Capacitance (Ciss) (Max) @ Vds:

5880 pF @ 10 V

Power Dissipation (Max):

1.4W (Ta)

Mounting Type:

Surface Mount

Package / Case:

8-TSSOP (0.173", 4.40mm Width)

## Environmental & Export classification

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99

REACH Status:

REACH Unaffected

HTSUS:

8541.29.0095



July 2008

FDW254PZ

# FDW254PZ

## P-Channel 1.8V Specified PowerTrench<sup>®</sup> MOSFET

### General Description

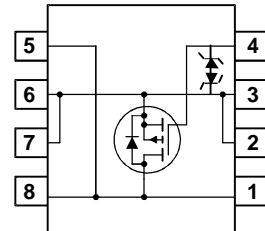
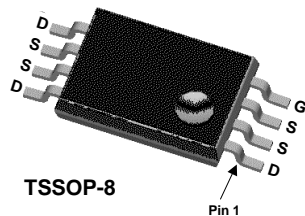
This P-Channel 1.8V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (1.8V – 8V).

### Applications

- Load switch
- Motor drive
- DC/DC conversion
- Power management

### Features

- -9.2 A, -20 V.  $R_{DS(ON)} = 12 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$   
 $R_{DS(ON)} = 15 \text{ m}\Omega @ V_{GS} = -2.5 \text{ V}$   
 $R_{DS(ON)} = 21.5 \text{ m}\Omega @ V_{GS} = -1.8 \text{ V}$
- Rds ratings for use with 1.8 V logic
- ESD protection diode
- Low gate charge
- High performance trench technology for extremely low  $R_{DS(ON)}$
- Low profile TSSOP-8 package



### Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Ratings	Units
$V_{DSS}$	Drain-Source Voltage	-20	V
$V_{GSS}$	Gate-Source Voltage	$\pm 8$	V
$I_D$	Drain Current – Continuous (Note 1) – Pulsed	-9.2	A
		-50	
$P_D$	Power Dissipation (Note 1a) (Note 1b)	1.4	W
		1	
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ\text{C}$

### Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a) (Note 1b)	96	$^\circ\text{C}/\text{W}$
		208	

### Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
254PZ	FDW254PZ	13"	12mm	2500 units

**Electrical Characteristics** $T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$BV_{DSS}$	Drain–Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = -250\ \mu\text{A}$	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250\ \mu\text{A}$ , Referenced to $25^\circ\text{C}$		-11		$\text{mV}/^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = -16\text{ V}, V_{GS} = 0\text{ V}$			-1	$\mu\text{A}$
$I_{GSS}$	Gate–Body Leakage	$V_{GS} = \pm 8\text{ V}, V_{DS} = 0\text{ V}$			$\pm 10$	$\mu\text{A}$
<b>On Characteristics (Note 2)</b>						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250\ \mu\text{A}$	-0.4	-0.6	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250\ \mu\text{A}$ , Referenced to $25^\circ\text{C}$		2		$\text{mV}/^\circ\text{C}$
$R_{DS(on)}$	Static Drain–Source On–Resistance	$V_{GS} = -4.5\text{ V}, I_D = -9.2\text{ A}$ $V_{GS} = -2.5\text{ V}, I_D = -7.9\text{ A}$ $V_{GS} = -1.8\text{ V}, I_D = -6.5\text{ A}$ $V_{GS} = -4.5\text{ V}, I_D = -9.2\text{ A}, T_J = 125^\circ\text{C}$		9 11 14 12	12 15 21.5 18	$\text{m}\Omega$
$I_{D(on)}$	On–State Drain Current	$V_{GS} = -4.5\text{ V}, V_{DS} = -5\text{ V}$	-50			A
$g_{FS}$	Forward Transconductance	$V_{DS} = -5\text{ V}, I_D = -9.2\text{ A}$		54		S
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS} = -10\text{ V}, V_{GS} = 0\text{ V},$		5880		pF
$C_{oss}$	Output Capacitance	$f = 1.0\text{ MHz}$		990		pF
$C_{rss}$	Reverse Transfer Capacitance			560		pF
$R_G$	Gate Resistance	$V_{GS} = 15\text{ mV}, f = 1.0\text{ MHz}$		4.9		$\Omega$
<b>Switching Characteristics (Note 2)</b>						
$t_{d(on)}$	Turn–On Delay Time	$V_{DD} = -10\text{ V}, I_D = -1\text{ A},$		15	27	ns
$t_r$	Turn–On Rise Time	$V_{GS} = -4.5\text{ V}, R_{GEN} = 6\ \Omega$		15	27	ns
$t_{d(off)}$	Turn–Off Delay Time			210	336	ns
$t_f$	Turn–Off Fall Time			100	160	ns
$Q_g$	Total Gate Charge	$V_{DS} = -10\text{ V}, I_D = -9.2\text{ A},$		60	96	nC
$Q_{gs}$	Gate–Source Charge	$V_{GS} = -4.5\text{ V}$		7		nC
$Q_{gd}$	Gate–Drain Charge			13		nC
<b>Drain–Source Diode Characteristics and Maximum Ratings</b>						
$I_S$	Maximum Continuous Drain–Source Diode Forward Current				-1.2	A
$V_{SD}$	Drain–Source Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = -1.2\text{ A}$ (Note 2)		-0.5	-1.2	V
$t_{rr}$	Reverse Recovery Time	$I_F = -9.2\text{ A},$		35		ns
$Q_{rr}$	Reverse Recovery Charge	$d_i/d_t = 100\text{ A}/\mu\text{s}$		21		nC

**Notes:**

- $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.
  - $R_{\theta JA}$  is  $96^\circ\text{C}/\text{W}$  (steady state) when mounted on a 1 inch<sup>2</sup> copper pad on FR-4.
  - $R_{\theta JA}$  is  $208^\circ\text{C}/\text{W}$  (steady state) when mounted on a minimum copper pad on FR-4.

- Pulse Test: Pulse Width  $< \mu\text{s}$ , Duty cycle  $< 2.0\%$ .

Typical Characteristics

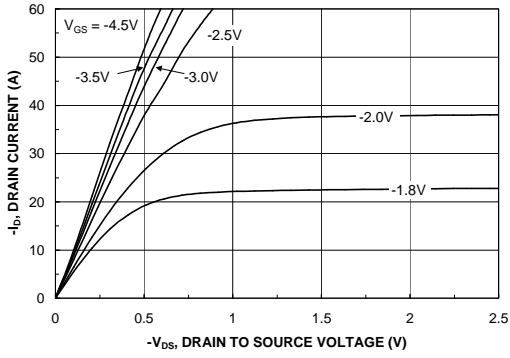


Figure 1. On-Region Characteristics.

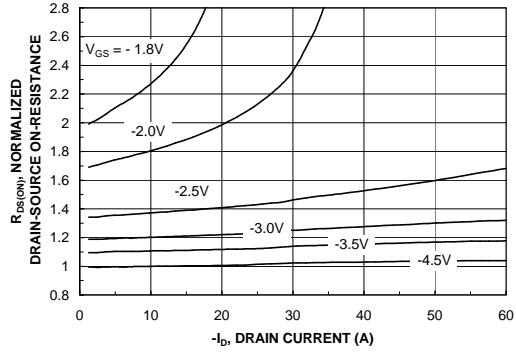


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

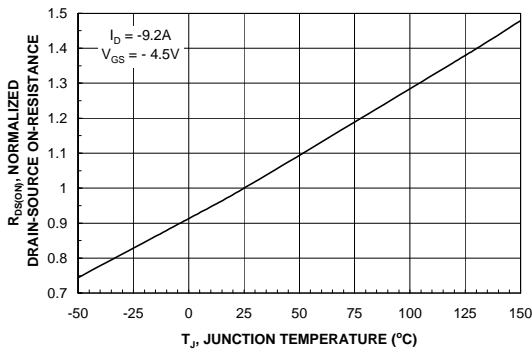


Figure 3. On-Resistance Variation with Temperature.

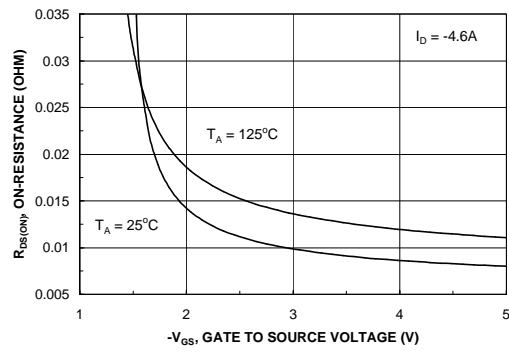


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

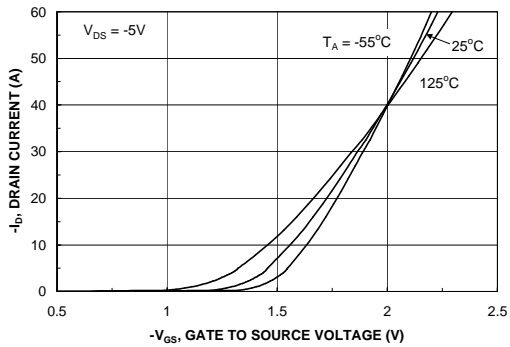


Figure 5. Transfer Characteristics.

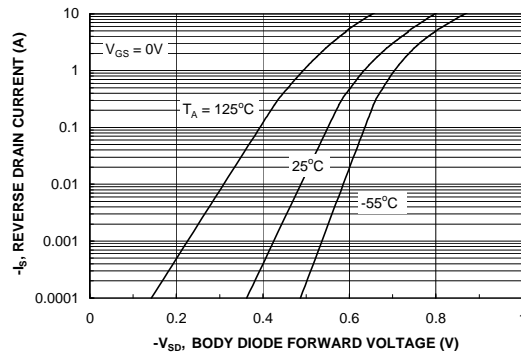


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Characteristics

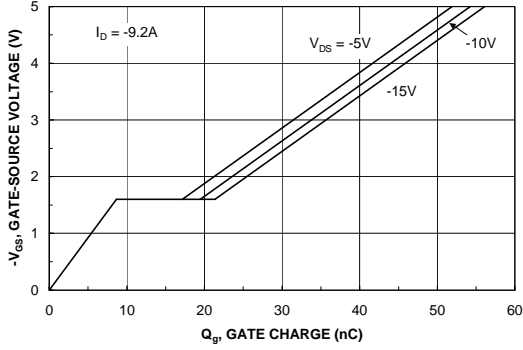


Figure 7. Gate Charge Characteristics.

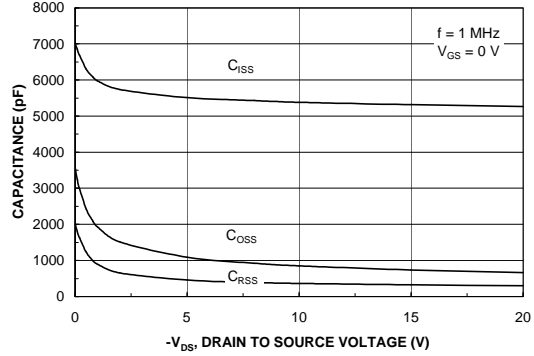


Figure 8. Capacitance Characteristics.

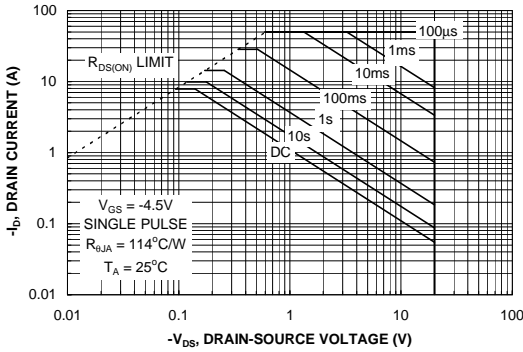


Figure 9. Maximum Safe Operating Area.

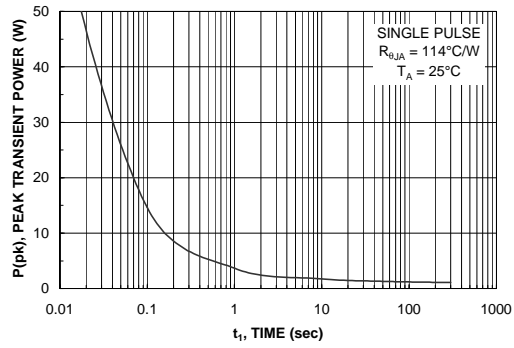


Figure 10. Single Pulse Maximum Power Dissipation.

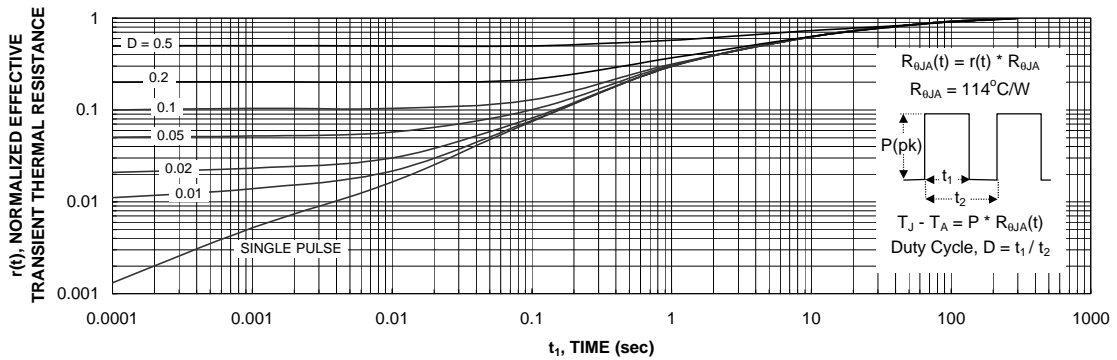


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.



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